COURSE NAME : DIPLOMA IN ELECTRONIC & TELECOMMUNICATION ENGINEERING

COURSE CODE : E T

SEMESTER : FIFTH

SUBJECT TITLE : COMPUTER ARCHITECTURE AND MAINTENANCE

SUBJECT CODE : ET 5001

Teaching and Examination Scheme:

Teaching Sche		Examination Scheme						
TH	PR	PAPER HRS	TH	INT	PR	OR	TW	TOTAL
03	02	03	80	20			25*	125

Pre-requisites :- Students should know the following concept

Pre-requisites :- Students should know the following concept

- 1) Basic knowledge of computer concepts
- 2) Basic knowledge of computer hardware

Objectives:- The student will be able to

- 1) To debug and repair the fault in system
- 2) To assemble the system
- 3) To load the operating system And device drivers in the system

Contents:	Theory
Unit	

Unit	Name of the Topic	Hours	Marks
01	Motherboard And Its Components	08	10
	Different types of PC configurations and their comparison Chipset basic, chipset Architecture : North/South Bridge architecture and Hub architecture Architecture of Intel chipset 915 G& 945 G Overview and features of ISA, PCI-X, PCI-Xpress, AGP, Processor Bus (no pin description) Comparison between PCI and PCI Express Logical memory organization : Conventional memory,		
	Extended memory, Expanded memory (No memory map) Concept of cache memory : Internal cache, External cache (L1, L2, L3 cache) Overview and features of SDRAM, DDR, SDRAM, DDR2, SDRAM, DDR3 BIOS Basics	00	10
02	 Storage Devices And Its Interfacing Recording Technique : RM, MFM, RLL Perpendicular magnetic recording Hard disk construction and working Terms related to Hard Disk : Track, Sector cylinder, cluster, Head parking, MBR, Zone recording Formatting, Low level formatting, High level formatting, partitioning Hard disk drive interface : features of parallel AT attachment (PATA), Serial AT Attachment (SATA), External SATA (no pin discription) CDROM drive : Construction, recording DVD : Construction, Recording 	08	10
03	Display Interfacing CRT colour monitor : Block diagram and function of each block Characteristics of CRT monitor : Dot pitch, Resolution, Video bandwidth, Horizontal scanning frequency, Interlaced versus non interlaced monitor Advantages of CRT display over LCD display LCD monitor : functional block diagram of LCD monitor, working principal, advantages and disadvantages Types:Passive matrix and Active matrix, Important characteristics : Resolution, Refresh rate, Response time.	05	10
	Basic block diagram of a video accelerator card	08	20
	Innut & Autnut Devices		

Input & Output Devices

Construction, working & Installation of : Keyboard.

	Mouse: Mechanical, Optomechanical, New optical Scanner: Types, Flat bed, Block diagram and specifications.Modem: Internal and External: Block diagram and specifications.Printer: Dot matrix, Inkjet, Laser: Block diagram and specifications		
05	Power Supplies	04	10
	Block diagram and working of SMPS. Signal description and pin diagram of AT and ATX connectors Power supply characteristics: Rated wattage, Efficiency,Regulation, Ripple, Load regulation, line regulation Power problems : Blackout, Brownout, surges and spikes Symptoms of power problems Protection devices : Surge suppressor : working UPS : Block diagram, working, Types, Rating		
06	Interfaces	05	10
	SCSI, SCSI cables and connectors, SCSI drive configuration.USB features RS232 : (Voltages & 9 pin Signal description) Centronics (interface diagram, signals and timing waveform)Firewire features		
07	PC Diagnostic, Testing And Maintenance And Tools	10	10
	Preventive Maintenance : Active Preventive maintenance, passive preventiv maintenance, periodic maintenance procedure Preventive maintenance of peripherals of PCs. Fault finding and troubleshooting of the above peripherals ESD (Electrostatic discharge), RFI protection Working of logic probe, logic purser, current		
	Total	48	80

List of experiments:

- 1. Study of components of Pentium IV motherboard
- 2. Study of HDD, its installation and partitioning
- 3. Study of Display adapter
- 4. Study of Keyboard
- 5. Study of Mouse and its types
- 6. Study of Flat bed scanner
- 7. Study of printers (Any one type, preferably Laser printer)
- 8. Study of modems
- 9. Study of SMPS
- 10. Study of UPS
- 11. Study of preventive maintenance of peripherals of PC

Recommended Books:

Pearson Educatio

Sr. No.	Author	Title	Publisher
01	Mike Meyers, Scott	Managing & Troubleshooting	Tata McGraw
02	Jernigan	PCs	Hill
02	Bigelow	Bigelow's Troubleshooting,	Tata McGraw
03	Mark Minasi	Maintaining & Repairing PCs The Complete PC Upgrade &	Hill
04	DBalasubramanian	Maintenance Guide	BPB Publication
05	Scott Mueller	Computer Installation &	
05	Scott Mueller	Servicing	Tata McGraw Hill
		Upgrading & Repairing PCs	

COURSE NAME : DIPLOMA IN ELECTRONICS & TELECOMMUNICATION ENGINEERING

COURSE CODE : ET

SEMESTER : FIFTH

SUBJECT TITLE : MICROCONTROLLER & MICROPROCESSOR

SUBJECT CODE : ET 5002

Teaching and Examination Scheme:

	hing eme	Examination Scheme						
TH	PR	Paper Hrs	TH	INT	PR	OR	TW	TOTAL
04	02	3	80	20	50**			150

Pre-requisites:-The students are expected to know the following concepts:

- 1) Architecture of 8085 microprocessor
- 2) Pin diagram of 8085 microprocessor
- 3) 8085 instruction set
- 4) Basic concept of I/O devices

Objectives :-The student should be able to :

- 1) Use data transfer techniques for serial & parallel communication
- 2) Describe the interfacing of I/O devices with 8085
- 3) Describe the RISC & CISC Architecture
- 4) Compare between Microprocessor & Microcontroller
- 5) Describe architecture and pin diagram of 8051
- 6) Develop assembly language program using instruction set of 8051

Contents: Theory

Unit 01	Name of thePeripheral DevicesTopicNeed of peripheralTopicData Transfer TechniquesSynchronous and AsynchronousSerial and ParallelHand shaking, Polling, Interrupt drivenMicroprocessor controlled with DMA(Only concept of DMA; no chip details)	Periods 02	marks 04
02	Programmable I/O Devices IC 8155 Block Diagram, pin out, operating modes, Simple I/O programs and Interfacing with 8085 Microprocessor.Comparison of features of 8155, 8355 and 8755 Minimum system configuration of 8085 Microprocessor.IC 8255 Block Diagram, pin out, operating modes,Simple I/O programs and Interfacing with 8085 Microprocessor.Interfacing of A to D Converter with 8085 Microprocessor.Interfacing of D to A Converter with 8085 Microprocessor.Practical Applications using 8085 Microprocessor.Stepper Motor ControlTemperature Control	12	18
03	Introduction to Microcontroller Comparison of Microprocessor, Microcontroller and Microcomputer. Evaluation of Microcontroller Terminology: - RISC, CISC, VLIW, Harvard and Von Neumann Architecture Memory types:- EEPROM and FLASH Commercial Microcontroller devices and families	02	06
04	8051 Microcontroller MCS-51 Architecture and details Pin configuration 8051 Hardware details- Clock, Oscillator, Registers, SFRs, DPTR, Flags, Stack, PC, Ports Internal RAM and ROM as Data Memory and Program Memory Connections of External Memory	14	18
05	Addressing Modes and Instructions of 8051 8051 Addressing modes MCS-51 Instruction Set Simple Programming	08	06

06	Assembly language programming of 8051 Development systems tools Editor, Assembler, Linker Creating various files to run the 8051 program (asm, obj, lst and hex files) 8051 Data Types and Directives (DB, ORG, EQU, END etc.) Software Simulators of 8051 SPJ Systems, Keil	02	08
07	Timers/Counters, Interrupts and Serial Communication Timer modes and programming of 8051 timers Study of SFRs of TimerTMOD and TCON in detail Interrupts of 8051 and their priority Study of IE and IP SFRs Study of SBUF, SCON and PLAN SFRs	08	20

Total 48 80

List of Practical:

- 1) 8155 Interfacing :(I/O Mode, Generation of square and sine wave using Timer mode)
- 2) 8255 Interfacing: (I/O Mode and BSR Mode Operations)
- 3) Generation of square, triangular and sine wave using DAC
- 4) Any one application of A to D converter Interfacing.
- 5) Stepper Motor Control
- 6) Addition, Subtraction, Multiplication and Division operations
- 7) Packing and unpacking of 8 bit data
- 8) Finding seven segment code using look up table
- 9) Square wave generation using internal timer of 8051

Recommended Books:

Sr. No.	Author	Title	Publisher
01	Deshmukh	Microcontrollers: Theory & Applications	Tata McGraw- Hill
02	Predko	Programming & Customizing	Tata McGraw-
03	Mazidi	8051 Microcontroller 8051 MicroController	Hill

COURSE NAME	: DIPLOMA IN ELECTRONICS & TELECOMMUNICATION ENGINEERING
COURSE CODE	: ET
SEMESTER	: FIFTH
SUBJECT TITLE	: DIGITAL COMMUNICATION
SUBJECT CODE	: ET 5003

Teaching and Examination Scheme:

Teac Sch	ching eme	Examination Scheme						
TH	PR	PaperTHINTPRORTWTOTALHrsImage: Constraint of the second sec					TOTAL	
04	02	3	80	20		25**		125

Pre-requisites:-To study digital communication, students should know the following concepts:

- 1) Basic concepts of communication
- 2) Basics of analog communication
- 3) Concepts of modulation
- 4) Analog modulation techniques
- 5) Need of multiplexing

Objectives:-After studying this subject students will be able to expain

- 1) Digital communication systems
- 2) Channel capacity theorem and entropy
- 3) Sampling theorem and aliasing effect
- 4) Generation of PAM ,PWM,and PPM
- 5) Transmission and reception of PCM ,DM,ADM,DPCM
- 6) Need to continuous wave modulation
- 7) Shift keying techniques and their applications
- 8) M-ary techniques
- 9) Multiplexing techniques
- 10) Multiple access techniques
- 11)Spread spectrum modulation, its types and applications

Subject Code: ET-5003

Contents: Theory

Unit	Name of the Topic	Hours	
01	Introduction of Digital Communication	Marks	
	Basic digital communication system, block diagram Channel capacity-definition, Hartley's law, Shannon-Hartley theorem, Channel capacity equation, channel noise and its effect, entropy Advantages and disadvantages of digital communication	04	08
02	 Pulse Communication Introduction, comparison with Continuous Wave Modulation, Advantages Sampling theorem, Nyquist rate, aliasing, natural & flat top sampling PAM, PWM, PPM definition, generation, block diagram,waveform analysis, and their comparison. Pulse code modulation- block diagram of PCM transmitter & receiver, sampling quantization, quantization error, compading, inter symbol interference Delta modulation- block diagram of DM, slope overload,granular noise.ADM, DPCM, block diagram and its working. 	14	18
03	Digital Modulation Techniques ASK, FSK, PSK definition & waveforms, their transmitter and receiver block diagram and working.M-ary encoding. QPSK, QAM, DPSK block diagram of transmitter and receiver and working. Bandwidth for each modulation technique and their comparison.	12	18
04	Coding methods and Error control Baud rate, Bit rate.Line coding - unipolar, bipolar - NRZ, RZ, Manchester Source coding, ASCII, EBCDIC and baudot code. Channel coding, Error, Causes of error and its effects, error detection & correction using parity, Hamming code & simple numerical.	06	10
05	Multiplexing and Multiple Access Need of Multiplexing, TDM, FDM definition block diagram and their comparison.Introduction to WDM Access technique TDMA, FDMA, CDMA (only concepts),advantages of TDMA over FDMA.	06	12
06	Spread spectrum modulation (Only Descriptive treatment) Introduction, PN Sequence. Model of spread spectrum modulation system. Direct sequence spread spectrum signal. Frequency hop spread spectrum, slow frequency hopping, and fast frequency hopping. Application S. S modulations.	06	14
	Total	48	80

- ¹ Observe waveforms of Pulse Amplitude modulation (using natural sampling & flat top
- $\frac{1}{2}$ sampling).
- 2. Observe waveforms of Pulse width modulation (using natural sampling & flat top
- 4. sampling)
- 5. Observe waveforms of Pulse Position modulation (using natural sampling.
- 6. Observe waveforms of Pulse code modulation and demodulation.
- Observe waveforms of Delta modulation.
 Observe waveforms of Adaptive delta Modulation.
 * Observe waveforms with change in amplitude of modulating Signal & Change in Sampling frequency.
- 7. Observe waveforms of ASK modulation & demodulation.
- 8. Observe waveforms of FSK modulation & demodulation.
- 9. Observe waveforms of PSK modulation & demodulation.
- 10. Observe waveforms of QPSK modulation & demodulation.
- 11. Observe waveforms of QAM modulation & demodulation.

12. Any one of the following:

- 1. Error detection & correction using parity bits.
- 2. Error detection & correction using hamming codes
- To generate following different line codes and decode them.
 NRZ (Unipolar) 2. Bipolar NRZ 3. RZ (Unipolar)4. Bipolar RZ

13. Any one of the following:

- 1. Time division multiplexing/ de multiplexing system.
- 2. Frequency division multiplexing/ de multiplexing system.

Recommended Books:

Sr.	Author	Title	Publisher
Sr. 01 02 03 04 05 06 07 08 09	Author Wayne Tomasi Louis E. Frenzl Roddy Collen Amitabha Bhattacharya K. Sam. & Shanmugar B. Sklar Siman Haykin J.S. Chitode Fronuzen	Title Electronic communication system Electronics Communication Communication System Digital Communication Digital & Analog Communication Digital Communication Fundamentals & Applications Digital Communication Digital Communication Digital Communication Digital Communication Digital Communication	Publisher Pearson Education Tata McGraw Hill Prentice Hall of India Tata McGraw Hill Jhon wiley & sons Pearson Education Jhon wiley & sons Technical Publication, Pune Tata Mc-graw Hill
		Networking	

COURSE NAME: DIPLOMA IN ELECTRONICS & TELECOMMUNICATION
ENGINEERINGCOURSE CODE: ETSEMESTER: FIFTHSUBJECT TITLE: POWER ELECTRONICSSUBJECT CODE: ET 5004

Teaching and Examination Scheme:

	ching eme			Ex	amination	Scheme		
TH	PR	Paper Hrs	TH	INT	PR	OR	TW	TOTAL
03	02	3	80	20			25*	125

Pre-requisites :-Before studying this subject the students should have basic understanding & knowledge of:

- 1) The basic semiconductor theory
- 2) Working principle of basic electronic devices and circuit

Objectives : -The student will be able to :

- 1) Draw & explain the V-I characteristics of various power electronic devices
- 2) Describe thyristor turn-on & turn-off mechanism
- 3) Explain working of polyphase rectifiers and their waveforms
- 4) Explain the working of controlled rectifier

Chapter	Power electronics Name of the Topic	Hours	Marks
01 02	Introduction to power electronics. Power transistor: Structure of vertical power transistor, I- V characteristics of power transistors, second breakdown, SOA: Safe operating Area.	02 08	6 20
	Thyristor family devices Brief introduction to Thyristor family devices: TRIAC, SUS, SCS, SBS, LASCR, PUT, GTO. Construction, Symbol, working and static V/I characteristicsof UJT, PUT, SCR, Diac, Triac, IGBT, MOS controlledthyristors, GTO. The two transistor analogy of SCR.		20
03	Turn ON and Turn OFF methods of Thyristor Introduction to Turn ON and Turn OFF methods of Thyristor Turn on methods - Forward Voltage triggering, Gate triggering, dv/dt triggering, thermal triggering of Thyristor. Gate trigger circuits - General block diagram of a thyristor gate trigger circuit, Resistance firing circuit, Resistance Capacitance firing circuit, Resistor Capacitor full wave trigger circuit. SCR triggering using UJT, PUT. Synchronised UJT triggering. Thyristor Turn OFF methods - Class A, B, C, D, E, F.	08	20
04	Polyphase Rectifiers Need and Use of Polyphase Rectifiers. Circuit diagram and waveforms of Three phase half wave Delta - Wye rectifier Six phase star half wave rectifier Three phase Delta - Wye Bridge Rectifier Phase controlled Rectifiers	04	10
05	Circuit diagram and waveforms of: Single phase half wave controlled rectifier (one - quadrant) with R, RL load. Effect of free wheeling diode. Single phase full wave controlled rectifier (two - quadrant converters) Midpoint converters (M 2 connection) R, RL load. Effect of free wheeling diode. Bridge configurations (B 2 connection) Fully controlled bridge circuit with inductive load (R L load) Rectifying mode Inverting mode Single Phase half controlled Bridge rectifier Half controlled bridge rectifier with Resistive load Half controlled bridge rectifier with R L load (No mathematical derivations)	10	24
	Total	32	80

A) List of Practical :

- 1) To plot V/I characteristics of Diac.
- 2) To plot V/I characteristics of Triac.
- 3) To plot V/I characteristics of SCR.
- 4) To find out values of latching and Holding current of SCR.5)
 - To plot V/I characteristics of IGBT.
- 6)

To study SCR phase control circuit.

7)

To study full wave mid - point circuit with resistive load.

B) Mini project:

- 1) Synchronized UJT triggering circuit.
- 2) Develop light dimmer circuit using diac and Triac.

Umesh Publications

Recommended Books:

Sr. No	Author	Title	Publisher
01	M D Singh K B Khan Chandani	Power Electronics	Tata McGraw-Hill
02	Muhammad H.	Power Electronics	Prentice Hall of
03	Rashid	Circuits Devices and	India
04	G K Mithal Dr Manisha Gupta	Applications Industrial and Power	Khanna Publishers
05	S N Biswas Harish C. Rai	Electronics Industrial Electronics	Dhanpat Rai and Sons
		Industrial and Power Electronics	

COURSE NAME
COURSE CODE: DIPLOMA IN ELECTRONICS &TELECOMMUNICATION ENGINEERINGSEMESTER: ETSUBJECT TITLE: AUDIO VIDEO ENGINEERINGSUBJECT CODE: ET 5005

Teaching and Examination Scheme:

	ching eme			Ex	amination	Scheme		
TH	PR	Paper Hrs	TH	INT	PR	OR	TW	TOTAL
03	02	3	80	20		25**	25*	150

Pre-requisites: The students must have knowledge of the following

- 1) Basics of communication system , such as modulation , EM waves etc
- 2) Working of basic electronics circuits such as amplifiers ,sweep generators, Power supplies etc.

Objectives: Students should be able to understand:

- 1) The basic idea of about the audio amplifier , public address system, graphic equalizer & dolby system
- 2) Monophonic and stereophonic stereo system . comparison between the monophonic and stereophonic systems
- 3) Mechanism of CD player controls available on Cd player & Cd player remote control .fault finding in CD player.
- 4) Monochrome & colour television details and fault findings Explain the concept of cable television and DTH services

Contents:

Theory			
·	Name of the Topic	Hours	Marks
Unit 01	 Hi Fi Audio Amplifier Introduction to Amplifiers: Mono, Stereo, Public Address. Difference between stereo amplifier & Mono amplifier. Block diagram of Hi Fi amplifier & explanation Controls available on it & its function & other facility available on it like (Mic in, Aux.in, earphone in) Graphic equalizer concept, circuit diagram and operation. (5 Point Circuit diagram) Dolby NR recording system Types of speaker - its comparison only I) woofer, II) Midrange, III) Tweeter Cross over network circuit & its function 	04	08
02	CD player CD - material used, size Block diagram of CD player & explanation. Principle & working of detection used in CD player. Component used for CD mechanism. I) CD pick-up assembly, II) gear system, III) drive motors, IV) CD lens. Function of controls. Parts, function of remote control (transmitter unit) & function of receiver used in CD player. Advantages of florescent display system used in CD player.	03	08
03	TV Fundamentals Concept & explanation of following: Aspect ratio, image continuity, interlace scanning, scanning periods horizontal & vertical, vertical resolution horizontal resolution. Vestigial sideband transmission, bandwidth for Colour signal, brightness, contrast, viewing distance luminance, hue, saturation, compatibility. Colour theory, primary colors & secondary colors, Grassman's law, additive Colour mixing subtractive Colour mixing. Composite Video Signal explain with waveform: Pedestal height, Blanking pulse, Colour burst, Horizontal sync pulse details, Vertical sync pulse details,	06	20
	Equalizing pulses, CCIR B standards for Colour signal transmission & reception. TV channel allocation for band I & band III.		

04	 TV Transmitters & Receiver Audio and Video signal transmission Positive and Negative modulation Merits and Demerits of Negative modulation Introduction to television camera tube (Working & principle only) a) Vidicon b) Plumbicon c) Solid State camera based on CCD. Color Picture tube (working & principle only). a) PIL b) Delta gun picture tube. Block diagram of monochrome TV transmitter (Function of each black) Block diagram of Colour TV transmitter. 	06	12
05	 Block diagram of colour TV transmitter. Block diagram of monochrome TV Receiver. Colour TV and Composite Video Signal Block Diagram & operation of color TV receiver (PAL D type), block diagram of PAL-D decoder Explain -Yagi Uda Antenna. with circuit diagram of chroma signal amplifier, Burst pulse blanking, Colour killer control, Basic Circuit for Separation of U & V signals. ACC Amplifier. Coluor signal matrixing, RGB drive amplifiers. EHT generation: circuit explanation for line output stage using transistor or IC in Colour TV. comparisons between NTSC, PAL & SCAM Systems. Explain with Waveform- Pedestal Height, Blanking Pulse, Colour Burst, Horizontal Pulse Sync Details, Vertical Pulse Sync Details, Equalising Pulses, CCIR B Standards for Colour Signal Transmission & Reception. TV Channel Allocation for Band I, III 	09	20
06	Cable Television Working Principle and Specification of foll components:- Dish antenna,LNMC,Multiplexer,Attenuators, Connectors (two ways & three ways), Amplifier & cable. MATV, CATV & CCTV. Design concept for cable TV network. Block diagram of dB meter with working principle. Direct to Home System (DTH) Introduction & Block Diagram	04	12
	. Total	32	80

List of Practical:

- 1. Study and observe the given component layout of a Hi Fi amplifier system.
 - a) Trace the output stage of given Hi Fi amplifier system.
 - b) Voltage analysis of a given Hi Fi amplifier.
- 2. Fault Finding (three different faults) in a Hi Fi Audio amplifier:
 - a) By Signal injection method.
 - b) Confirmation of faulty stage by voltage analysis method.
- 3. To plot frequency response of graphic equalizer
- 4. Draw and study drive mechanism layout of CD Player.
- 5. Fault finding in CD player (Three different faults)
- 6. Tracing of chroma section in given TV receiver.
- 7. Tracing of picture tube and video amplifier in given TV receiver with
- 8. multimeter.
- 9. Tracing of horizontal section in given TV receiver with multimeter. Voltage analysis of picture tube, chroma section and horizontal section.
- 10. Fault finding in given Colour TV :
 - a) No color b) Red Colour only c) Blue color only d) Green color only.
 - e) Magenta color only f) Cyan only g) Yellow only h)No raster. No Sound.
- 11. a) Fault in HSYNC section.b) Fault in VSYNC section.
- 12. Fault in SYNC separator.
- 13. Installation of DTH System.
- 14. Estimate the cost, layour of Cable TV.
- 15. Collect information about Set Top box used for Cable TV at home.

Recommended Books:

Sr. No.	Author	Title	Publisher
01	A.M Dhake	Television & Radio Engineering	Tata McGraw-Hill
02	R.G Gupta	Television Engg and Video System	Tata McGraw-Hill
03	R.G Gupta	Audio Video Systems	Tata McGraw-Hill
04	R.R Gulati	Modern TV Pratice	New age International
05	S. Sharma	Basic Radio and Television	Tata McGraw-Hill
06	R.R Gulati	Colour Television Principles and Pratice	New age International
07	Bernard Grob	Basic Television and Video System	Tata McGraw-Hill
08	R.R Gulati	Mono Chrome and Colour Television	New age International
09	Manohar Lotia	Modern CD Player Servicing Manual	BPB Publication

COURSE NAME	: DIPLOMA IN ELECTRONICS & TELECOMMUNICATION ENGINEERING
COURSE CODE	: ET
SEMESTER	: FIFTH
SUBJECT TITLE	: MAINTENANCE OF ELECTRONICS EQUIPMENT
SUBJECT CODE	: ET5006

Teaching and Examination Scheme

Teac Sch	ching eme			Ex	amination	Scheme		
TH	PR	Paper Hrs	TH	INT	PR	OR	TW	TOTAL
	03				50**			50

Pre-requisites: Student should know the following:

- 1) Basic knowledge of electronic
- 2) Capable of measuring different parameters using various electronic equipment
- 3) Concept of troubleshooting
- 4) Knowledge of fault finding

Objectives: Students should be able to:

- 1) To develop analysis of circuit working
- 2) To find equivalent component using datasheets
- 3) Effective use of service manual and computer
- 4) Effective use of internet
- 5) Acquire knowledge about circuit tracing
- 6) Develop troubleshooting, maintenance and testing knowledge

Contents:

Name of the

Unit 01	Topic Reliability aspects of electron	nic equipment	Hours 04
•1	Traditional bathtub relia	ability	•••
	curve	•	
	• Generalized reliability c	curve	
	• Mean time to fail		
	• Failure rate		
	• Mean time between fail	ure	
	• Mean time to repair		
	• Mean time to restore sys	stem	
	• Thermal acceleration		
	Electrical acceleration		
	• Damp heat acceleration		
	Practical reliability		
	Quality standards		
	Maintenance policy		
	Preventive maintenance	;	
	Corrective maintenance		
	Qualitative Maintenance	e	
02	Maintenance Management		10
-	Maintenance policy		
	Equipment service optic	ons	
	• Types of contract		
	General contract provisi	ion	
	Maintenance organization	on	
	Training Maintenance P	Personal	
	• Planning of spare parts	inventory	
	 Assessing spare parts re 	quirement	
	• Essentials of a good equ	ipment management	
	programme		
	 Planning for new equips 	ment	
	 Acquisition process 		
	 Planning of utilities 		
	 Incoming inspection 		
	 Inventory control 		
	• User training		
	 Technical training 		
	• Management of service	manual and reference library	
	Maintenance Arrangeme	ent	
	 Calibration Check 		
	Preventive Maintenance	}	
	ALERT Issue		
	Quality Assurance		
	Installation procedure		
	Environmental consider	ations	
	• Humidity		
	• Altitude		
	Shock and vibrations		
	Protection from electro-	magnetic interference	
	• Safety		
	Service and maintenanc	e laboratory 147	
		11/	

Work bench Power for work bench Lighting

Storage

•

- Maintenance system overview
- Log book
- Performa for recording
- specifications
- Performa for preventive
- maintenance
- Performa for corrective
- maintenance
- Data Analysis
- Information Tags
- Personal Safty

03 Fundamental Troubleshooting Procedure

- Reading of block diagram
- Reading of circuit diagram
- Reading of working diagram
- Di-assembly
- Re-assembly
- Trouble shooting process
- Fault establishment
- Fault correction
- Fault finding aids
- Service, Maintenance & Instruction manuals
- Test and measuring Tools
- Pre Trouble shooting technique
- Preliminary observation
- Functional area approach
- Split half method
- Divergent path
- Convergent path
- Feed back path
- Systematic troubleshooting checks
- Check control selting
- Checks associated equipments
- CalibY astron check
- Isoltes the troubling
- cirouit
 - Measurement
- Individual components

Trouble shooting procedure

04

- 1. Visual inspection
- 2.Measure

Voltage levels Presence of signal & the signal waveform

3.Component failure

Out of circuit test In circuit Test

4. Signal Tracing 148

5. Functional analysis

02

14

05 Trouble shooting

aids

Tools

- Service manual
- Circuit diagram
- Circuit board location
- Voltage analysis
- Fault finding flow
- check
- Diagnostic software List of replace able parts

Data manuals

Trouble shooting technique

- Voltage
- analysis
- Signal injection Signal tracing

Total 32

02

Practical:

- 1. Testing of resister, capacitor and inductance by using multimeter and LCR meter,
- 2. CRO.
- 3. Testing of Transistor by using multimeter and transistor TESTER, CRO
- 4. Testing of IC using IC tester
- Testing of variable resisters, connector, switches, by using multimeter. Testing of diodes, zener diode, varactor diode, VDR, Photo diode, Tunnel diode, LDR, Thermister, 7 segment display, FET, MOSFET, SCR, Triac with help of multimeter (testing Zig)
- LAY OUT OF Components in given power supply Tracing of voltage regulation section in given power supply Voltage analysis in given power supply Fault finding in given power supply by voltage analysis method Fault finding in power supply by voltage analysis method.
- 7. LAYOUT of components for given function generator Tracing of alternation section used in function generator Voltage analysis in given function generator

Fault finding in function generator by voltage analysis method

Fault finding in function generator by voltage analysis method

Fault finding in function generator by voltage analysis method.

- 8. Layout of components for given CRO
- Tracing a vertical section used in CRO
- Voltage analysis in CRO
- Signal Tracing in CRO
- Fault finding in CRO by voltage analysis method
- Fault finding in CRO by voltage analysis method
- Fault finding in CRO by voltage analysis method Fault
- finding in CRO by signal Tracing method.
- 9. Visit web site to get information about manufactures, Specification and cost. Which will be

filled in tabular form for following measurement and Testing equipment's (ANY 5)

- 1. logic analyzer
- $\frac{1}{2}$ logic probe
- $\frac{1}{3}$ logic pulser
- $\frac{1}{4}$ logic chip
- 5. Waveform generator
- 6. Pattern generator
- 7. IC Tester
- 8. Curve Tracer
- 9 RF power meter
- 10. Field strength meter
- 11. Distortion factor meter
- 12. Accessories for SMD soldering and disordering
- 13. Soldering & disordering station
- 14. Digital storage oscilloscope
- 15. Spectrum analysis
- 10. Draw the layout with the help of computer
 - 1. Performa for recording specification in log
 - 2. look
 - 3. Performa for preventive maintenance
 - 4. Performa for corrective maintenance
 - 5. Performa for data analysis
 - 6. Layout for service department
 - 7. Layout for store department
 - Layout for servicing table
- 11. Find equivalent components by using data book/ Internet (at least five components in each type)
 - 1. Transistors
 - 2. Diodes
 - 3. FET/MOSFE
 - 4. T
 - 5. IC TTL
 - IC CMOS
- 12. Prepare fault finding flow chart using computer (at least for two faults in each equipments)
 - Power supply
 - Function
 - generator CRO

13. Collect the catlog from market/ Internet and write down the information about specification manufacture, cost for the following (at least five from each group)

(A)

Resister	LCD Display		
Capacitor	LED Display		
Inductors	Microprocessor		
Transformer	Micro controller		
Diode	Switches		
Darlington Tr	Fuses		
FET	IC Sockets		
MOSFET	Solder materials		
IGBT	Soldering station		
Photo devices	Desolder (widing		
TTL IC	pump)		
CMOS IC	heak sink		
Thyristors			
(B)			
Pliers Cutters Spanners (Wrenches) Screw drivers Jewelers screw drivers Hack jaw Hand drill & drills Files	malement of drilling grinding polici		
Hand held power tools & whole complement of drilling, grinding, polis			

Hand held power tools & whole complement of drilling, grinding, polishing, soldering and cutting attachment

(C)

Brushes Blades Sponge Inspection mirror Magnifying glass Thread Sleeves

(D)

Contact cleaners Control cleaners Lubricants (WD40, LPSI) Flux remover Tunner cleaner Adicheives Solvent release Silicon rubber

Industrial Visit:

- 1. Any service dept. in electronic factory
- 2. Any service enterprises in your city related with electronic goods.

Recommended Books:

Sr.	Author	Title	Publication
Sr. No. 01	R.G. Gupta	Electronic Instruments & System	Tata MacGraw Hill
02	R.S. Khandpar	Trouble Shooting Electronic	Tata MacGraw Hill
02	G.C. Loveday	Equipment	Longman scientific
03		Electronic Testing & Fault Diagonis	and technical

COURSE NAME	: ELECTRONIC & TELECOMMUNICATION ENGINEERING
COURSE CODE	: ET
SEMESTER	: FIFTH
SUBJECT TITLE	: Professional Practices-V
SUBJECT CODE	: ET 5007

Teaching and Examination Scheme:

Teac Sch	ching eme	Examination Scheme						
TH	PR	Paper Hrs	TH	INT	PR	OR	TW	TOTAL
	03						50*	50

Prerequisites: While selecting candidates a normal practice adopted is to see

- 1) General confidence and ability to communicate.
- 2) Basic technological concepts.

Objectives: The student will be able to

- 1) Acquire information from different sources
- 2) Prepare notes for given topic
- 3) Present given topic in a seminar
- 4) Interact with peers to share thoughts
- 5) Prepare a report on industrial visit, expert lecture

Subj	ect Title : PROFESSIONAL PRACTICES-V Subject C	ode: ET-5007
Units	Activity	Hour
01	Structured industrial visits shall be arranged and report of the same shoul	d
	be submitted by the individual student, to form a part of the term work.	14
	Following are the suggested type of Industries/ Fields -(Any three visits)	
	i) Data Acquisition System	
	ii) Sugar Mill, Paper Mill, Cement Industry	
	iii) Satellite Earth Station	
	iv) Railway Station Control Room	
	v) Digital RPM Meter Manufacturing Unit	
	vi) Industry where Digital Drives are used	
	vii) Digital Counters	
02	The Guest Lecture/s from field/industry experts, professionals to be arranged (2 Hrs), minimum 2 nos. from the following or alike topics. Students should submit a brief report on the guest lecture as part of Terr	12 n
	Work	
	a) Emerging Technology	
	b) Peripheral Devices	
	c) Blue Tooth Technology	
	d) Energy Crisis and Alternative Energy Sources	
	e) Digital Invertors	
	f) Total Quality Management	
03	g) Six Sigma	
03	Information Search ,data collection and writing a report on the topic a) CDMA	16
	a) CDMAb) GPS	
	c) Manufacturing process of ICs	
	d) WLL Technology	
04	Group Discussion:	10
	The students should discuss in group of six to eight students and write a brief	
	report on the same as a part of term work. The topic of group discussions may	be
	selected by the faculty members. Some of the suggested topics are -	
05	Seminar :	12
05	Seminar topic should be related to the subjects of fifth semester Each student shall submit a report of 5 to10 pages and deliver a seminar (Presentation time 10 minutes)	
		tal =64

COURSE NAME	: ELECTRONICS & TELECOMMUNICATION ENGINEERING
COURSE CODE	: ET
SEMESTER	: FIFTH
SUBJECT TITLE	: INDUSTRIAL PROJECT AND ENTREPRENEURSHIP DEVELOPMENT
SUBJECT CODE	:ET 5008

Teaching and Examination Scheme:

Teaching Scheme				Exa	amination	Scheme		
ТН	PR	Paper Hrs	TH	INT	PR	OR	TW	TOTAL
01	02						25*	25

1. Form project batches & allot project guide to each batch. (Max. 4 students per batch)

- 2. Each project batch should select topic / problem / work by consulting the guide & / orindustry. Topic / Problem / work should be approved by Head of department.
- **3.** Each project batch should prepare action plan of project activities & submit the same to respective Guide
- 4 At the end of semester, each project batch should submit the action plan and abstract of the
- 5. project along with list of materials required if project involves fabrication or other facilities required in other kinds of project. Action Plan should be part of the project report.

Notes:

- 1. One theory and Two practical hours are for Building Services and Oral based on term work
- 2. One theory and one tutorial hour are for Entrepreneurship Development (EDP).
- Twenty five marks for term work are for report prepared under EDP

Content:

Part A) Industrial Project

Following activities related to project are required to be dealt with, during this semester.

1) Knowledge of "principles of manangement" is required

Objectives:Student will be able to

- 1) Indentify entrepreneurship opportunity
- 2) Acquire entrepreneurial values and attitude
- 3) Use the information to prepare project report for business venture
- 4) Develop awareness about enterprise management

	s: Theory s: Theory	
Unit 01	Name of the Topic Entrepreneurship, Creativity & Opportunities Concept, Classification & Characteristics of Entrepreneur Creativity and Risk taking.Concept of Creativity & Qualities of Creative person.Risk Situation, Types of risk & risk takers. Business Reforms_Process of Liberalization.Reform Policies. Impact of Liberalization Emerging high growth areas. Business Idea Methods and techniques to generate business idea. Transforming Ideas in to opportunities transformation involves Assessment of idea &Feasibility of opportunity SWOT Analysis	Hours 03
02	Information And Support Systems Information Needed and Their Sources.Information related to project, Information related to support system,Information related to procedures and formalities SUPPORT SYSTEMS Small Scale Business Planning, Requirements.Govt. & Institutional Agencies, Formalities Statutory Requirements and Agencies.	03
03	Market Assesment Marketing -Concept and Importance Market Identification, Survey Key components Market Assessment	
04	Business Finance & Accounts Business Finance Cost of Project Sources of Finance	02
2	Assessment of working capital Product costing Profitability Break Even Analysis Financial Ratios and Significance	03
06	 Business Account Accounting Principles, Methodology 1) Book Keeping 2) Financial Statements 3) Concept of Audit, 	

Business Plan & Project Report

Business plan steps involved from concept to commissioning- Activity Recourses, Time, Cost

Project Report

05

06

- 1) Meaning and Importance
- 2) Components of project report/profile (Give list)

Project Apprisial

- 1) Meaning and definition
- 2) Technical, Economic feasibility
- 3) Cost benefit Analysis

Enterprise Management And Modern Trends Enterprise Management:

- 1) Essential roles of Entrepreneur in managing enterprise
- 2) Product Cycle: Concept And Importance
- 3) Probable Causes Of Sickness
- 4) Quality Assurance : Importance of Quality, Importance of testing

E-Commerce

Concept and process

Global Entrepreneur

Total 16

Assignments

Assess yourself-are you are entrepreneur? Prepare project report and study its feasibility

Recommended Books:

Sr.No	Author	Name Of Book	Publisher
1	J.S. Saini B.S.Rathore	Entrepreneurship Theory and Practice	Wheeler Publisher Himalaya
2	E. Gorden K.Natrajan	Entrepreneurship Development	Publishing.
3	Preferred by Colombo Plan Staff College for Technician Education.	Entrepreneurship Development	Tata Mc Graw Hill
4	J.B.Patel D.G.Allampally	A Manual on How to Prepare a Project Report	EDI STUDY MATERIAL Ahmadabad (Near Village)
5	J.B.Patel S.S.Modi	A Manual on Business Opportunity Identification & Selection	Bhat , Via Ahmadabad

02

6	S.B.Sareen H. Anil Kumar	National Derectory of Entrepreneur Motivator & Resource Persons.	Airport & Indira Bridge), P.O. Bhat 382428,
7	Gautam Jain Debmuni Gupta	New Initiatives in Entrepreneurship Education	Gujrat,India P.H. (079) 3969163,
8	P.C.Jain	& Training A Handbook of New	3969153 E-mail :
9	D.N.Awasthi , Jose Sebeastian	Enterpreneurs Evaluation of Enterpreneurship Development Programmes	ediindia@sancharnet.in/o lp
10	V.G.Patel	The Seven Business Crisis & How to Beat Them.	<u>e@ediindia.org</u> Website : http://www.ediindia.org

2) Video Cassettes

NO	SUBJECT	SOURCE
1	Five success Stories of First	EDI STUDY MATERIAL
1	Generation	Ahmadabad (Near Village Bhat, Via
2	Entrepreneurs	Ahmadabad Airport & Indira Bridge),
3	Assessing Entrepreneurial Competencies	P.O.
5	Business Opportunity Selection and	Bhat 382428 , Gujrat,India
4	Guidance	P.H. (079) 3969163, 3969153
_	Planning for completion & Growth	E-mail :
5	Problem solving-An Entrepreneur	ediindia@sancharnet.in/olpe@ediindia.o
	Skill	<u>rg</u>
		Website : http://www.ediindia.org

Components of Project Report:

- 1. Project Summary (One page summary of entire project)
- 2. Introduction (Promoters, Market Scope/ requirement)
- 3. Project Concept & Product (Details of product)
- 4. Promoters (Details of all Promoters- Qualifications, Experience, Financial
- 5. strength)
- 6. Manufacturing Process & Technology
- 7. Plant & Machinery Required
- 8. Location & Infrastructure required
- 9. Manpower (Skilled, unskilled) Raw materials, Consumables & Utilities
- 10. Working Capital Requirement(Assumptions, requirements) 11. Market (Survey, Demand & Supply)
- 12. Cost of Project, Source of Finance
- 13. Projected Profitability & Break Even Analysis
- 14. Conclusion.